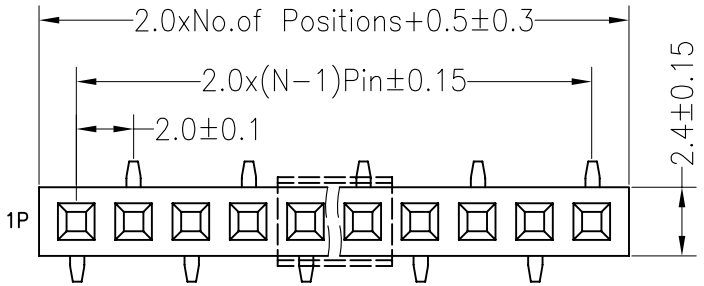
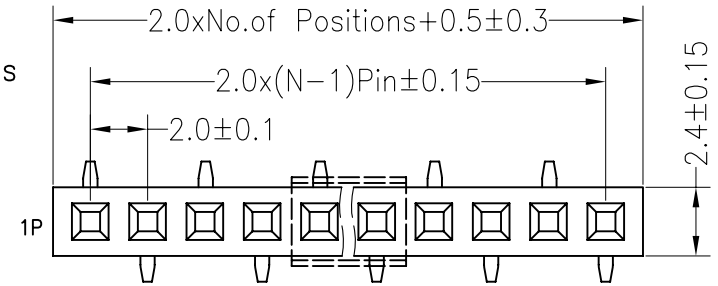
HSF RoHS

FILE NO :E362810

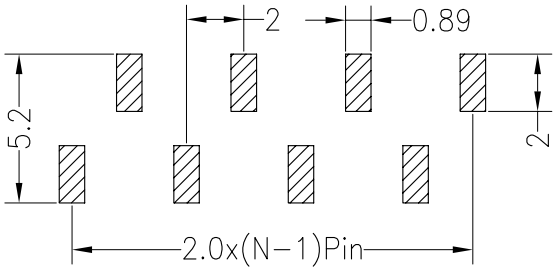
SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

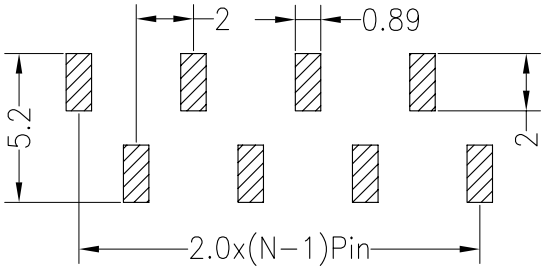




Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



TYPE01

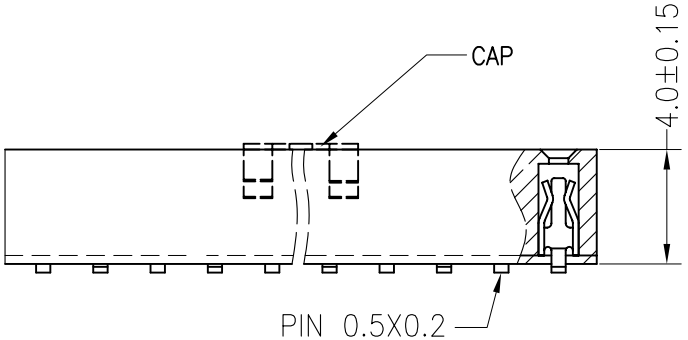


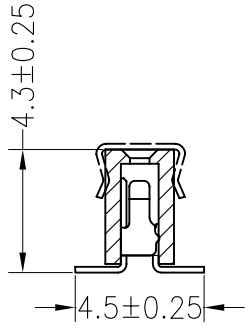
TYPE02

Ordering Information

2340 01 XX X N XX M U X 0X(1,2)

No.of Pins Per Row 1*1~1*40	Insulator Material Option		Contact Plating		Packing
	A=BK−PBT		G0:Gold Flash		0=PE Bag
	B=BK−PA66		G1:3U" Gold		A=Tray
	C=BK−PA6T		G2:5U" Gold		T=Tube
	D=BK−PA46		G3:10U" Gold		P=Tube+Cap
	E=BK−PA9T		G4:15U" Gold		R=Reel+Cap
	F=BK−LCP		G5:30U" Gold		M=Reel+Mylar
			S0:Gold Flash/Tin		
			SN:Tin		





REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.04.18	NEW DRAWING	

OPERATION		DRAW	Liu Miao	12.04.18
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	234001XXXNXXMUX01(2)
TITLE:	2.00PF H4.00mm 1xNpin SMT